

Amendments to the Claims:

This listing of claims replaces all prior versions and listings of claims in the application:

Listing of Claims:

1. (Currently Amended) A light-emitting apparatus comprising:  
a light-emitting device including a first electrode formed over a substrate, an electroluminescent film formed over the first electrode, and a second electrode formed over the electroluminescent film;  
an inorganic insulating film formed in contact with the second electrode;  
a film containing fluoroplastics formed over the inorganic insulating film; and  
a sealing substrate positioned over the film containing fluoroplastics with a space interposed therebetween,  
wherein the sealing substrate is bonded to the substrate by a sealant so that the light-emitting device, the inorganic insulating film and the film containing fluoroplastics are encapsulated.
2. (Original) A light-emitting apparatus according to claim 1, wherein the film containing fluoroplastics is one type of polymer selected from polytetrafluoroethylene, tetrafluoroethylene-hexafluoropropylene copolymer, polychlorotrifluoroethylene, tetrafluoroethylene-ethylene copolymer, polyvinyl fluoride, and polyvinylidene fluoride.
3. (Original) A light-emitting apparatus according to claim 1, wherein the inorganic insulating film is one type selected from silicon nitride, silicon oxynitride, aluminum nitride, and aluminum oxynitride.
4. (Currently Amended) A light-emitting apparatus comprising:

a light-emitting device including a first electrode formed over a substrate, an electroluminescent film formed over the first electrode, and a second electrode formed over the electroluminescent film;

an inorganic insulating film formed over the second electrode;

an organic insulating film formed over the inorganic insulating film;

a film containing fluoroplastics formed over the organic insulating film; and

a sealing substrate positioned over the film containing fluoroplastics,

wherein the sealing substrate is bonded to the substrate by a sealant so that the light-emitting device, the inorganic insulating film, the organic insulating film and the film containing fluoroplastics are encapsulated.

5. (Original) A light-emitting apparatus according to claim 4, wherein the film containing fluoroplastics is one type of polymer selected from polytetrafluoroethylene, tetrafluoroethylene-hexafluoropropylene copolymer, polychlorotrifluoroethylene, tetrafluoroethylene-ethylene copolymer, polyvinyl fluoride, and polyvinylidene fluoride.

6. (Original) A light-emitting apparatus according to claim 4, wherein the inorganic insulating film is one type selected from silicon nitride, silicon oxynitride, aluminum nitride, and aluminum oxynitride.

7. (Original) A light-emitting apparatus according to claim 4, wherein the organic insulating film is formed of any one of acrylic, polyamide, or polyimide.

8. (Currently Amended) A light-emitting apparatus comprising:

a light-emitting device including a first electrode formed over a substrate, an electroluminescent film formed over the first electrode, and a second electrode formed over the electroluminescent film;

a first inorganic insulating film formed over the second electrode;

an organic insulating film formed over the inorganic insulating film;  
a second inorganic insulating film formed over the organic insulating film;  
a film containing fluoroplastics formed over the second inorganic insulating film; and  
a sealing substrate positioned over the film containing fluoroplastics,

wherein the sealing substrate is bonded to the substrate by a sealant so that the light-emitting device, the first inorganic insulating film, the organic insulating film, the second inorganic insulating film and the film containing fluoroplastics are encapsulated.

9. (Original) A light-emitting apparatus according to claim 8, wherein the film containing fluoroplastics is one type of polymer selected from polytetrafluoroethylene, tetrafluoroethylene-hexafluoropropylene copolymer, polychlorotrifluoroethylene, tetrafluoroethylene-ethylene copolymer, polyvinyl fluoride, and polyvinylidene fluoride.

10. (Original) A light-emitting apparatus according to claim 8, wherein each the first inorganic insulating film and a second inorganic insulating film is one type selected from silicon nitride, silicon oxynitride, aluminum nitride, and aluminum oxynitride.

11. (Original) A light-emitting apparatus according to claim 8, wherein the organic insulating film is formed of any one of acrylic, polyamide, or polyimide.

12. (Currently Amended) A light-emitting apparatus comprising:  
a light-emitting device including a first electrode connecting electrically to a TFT formed over a substrate via an insulating film, an electroluminescent film formed over the first electrode, and a second electrode formed over the electroluminescent film;  
an inorganic insulating film formed over the second electrode;  
a film containing fluoroplastics formed over the inorganic insulating film; and  
a sealing substrate positioned over the film containing fluoroplastics with a space interposed therebetween.

wherein the sealing substrate is bonded to the substrate by a sealant so that the light-emitting device, the inorganic insulating film and the film containing fluoroplastics are encapsulated.

13. (Original) A light-emitting apparatus according to claim 12, wherein the film containing fluoroplastics is one type of polymer selected from polytetrafluoroethylene, tetrafluoroethylene-hexafluoropropylene copolymer, polychlorotrifluoroethylene, tetrafluoroethylene-ethylene copolymer, polyvinyl fluoride, and polyvinylidene fluoride.

14. (Original) A light-emitting apparatus according to claim 12, wherein the inorganic insulating film is one type selected from silicon nitride, silicon oxynitride, aluminum nitride, and aluminum oxynitride.

15. (Currently Amended) A light-emitting apparatus comprising:  
a light-emitting device including a first electrode connecting electrically to a TFT formed over a substrate via an insulating film, an electroluminescent film formed over the first electrode, and a second electrode formed over the electroluminescent film;  
an inorganic insulating film formed over the second electrode;  
an organic insulating film formed over the inorganic insulating film;  
a film containing fluoroplastics formed over the organic insulating film; and  
a sealing substrate positioned over the film containing fluoroplastics,  
wherein the sealing substrate is bonded to the substrate by a sealant so that the light-emitting device, the inorganic insulating film, the organic insulating film and the film containing fluoroplastics are encapsulated.

16. (Original) A light-emitting apparatus according to claim 15, wherein the film containing fluoroplastics is one type of polymer selected from polytetrafluoroethylene, tetrafluoroethylene-hexafluoropropylene copolymer, polychlorotrifluoroethylene, tetrafluoroethylene-ethylene copolymer, polyvinyl fluoride, and polyvinylidene fluoride.

17. (Original) A light-emitting apparatus according to claim 15, wherein the inorganic insulating film is one type selected from silicon nitride, silicon oxynitride, aluminum nitride, and aluminum oxynitride.

18. (Original) A light-emitting apparatus according to claim 15, wherein the organic insulating film is formed of any one of acrylic, polyamide, or polyimide.

19. (Currently Amended) A light-emitting apparatus comprising:  
a light-emitting device including a first electrode connecting electrically to a TFT formed over a substrate via an insulating film, an electroluminescent film formed over the first electrode, and a second electrode formed over the electroluminescent film;  
a first inorganic insulating film formed over the second electrode;  
an organic insulating film formed over the first inorganic insulating film;  
a second inorganic insulating film formed over the organic insulating film;  
a film containing fluoroplastics formed over the second inorganic insulating film; and  
a sealing substrate positioned over the film containing fluoroplastics,  
wherein the sealing substrate is bonded to the substrate by a sealant so that the light-emitting device, the first inorganic insulating film, the organic insulating film, the second inorganic insulating film and the film containing fluoroplastics are encapsulated.

20. (Original) A light-emitting apparatus according to claim 19, wherein the film containing fluoroplastics is one type of polymer selected from polytetrafluoroethylene, tetrafluoroethylene-hexafluoropropylene copolymer, polychlorotrifluoroethylene, tetrafluoroethylene-ethylene copolymer, polyvinyl fluoride, and polyvinylidene fluoride.

21. (Original) A light-emitting apparatus according to claim 19, wherein each the first inorganic insulating film and a second inorganic insulating film is one type selected from silicon nitride, silicon oxynitride, aluminum nitride, and aluminum oxynitride.

22. (Original) A light-emitting apparatus according to claim 19, wherein the organic insulating film is formed of any one of acrylic, polyamide, or polyimide.

23. (Previously Presented) A light-emitting apparatus according to claim 1, wherein the light-emitting device is sealed by the substrate and the sealing substrate.

24. (Previously Presented) A light-emitting apparatus according to claim 4, wherein the light-emitting device is sealed by the substrate and the sealing substrate.

25. (Previously Presented) A light-emitting apparatus according to claim 8, wherein the light-emitting device is sealed by the substrate and the sealing substrate.

26. (Previously Presented) A light-emitting apparatus according to claim 12, wherein the light-emitting device is sealed by the substrate and the sealing substrate.

27. (Previously Presented) A light-emitting apparatus according to claim 15, wherein the light-emitting device is sealed by the substrate and the sealing substrate.

28. (Previously Presented) A light-emitting apparatus according to claim 19, wherein the light-emitting device is sealed by the substrate and the sealing substrate.

29. (New) A light-emitting apparatus according to claim 4, wherein the sealing substrate is positioned over the film containing fluoroplastics with a space interposed therebetween.

30. (New) A light-emitting apparatus according to claim 8, wherein the sealing substrate is positioned over the film containing fluoroplastics with a space interposed therebetween.

31. (New) A light-emitting apparatus according to claim 15, wherein the sealing substrate is positioned over the film containing fluoroplastics with a space interposed therebetween.

32. (New) A light-emitting apparatus according to claim 19, wherein the sealing substrate is positioned over the film containing fluoroplastics with a space interposed therebetween.